



IR Detector for Mid Range Proximity Sensor



22531

DESCRIPTION

The TSSP57P38 is a compact infrared detector module for proximity sensing application. It receives 38 kHz modulated signals and has a peak sensitivity of 940 nm.

The length of the detector's output pulse varies in proportion to the amount of light reflected from the object being detected.

FEATURES

- Height of 0.8 mm
- Up to 2 m for proximity sensing
- Receives 38 kHz modulated signal
- Photo detector and preamplifier in one package
- Low supply current
- Shielding against EMI
- Visible light is suppressed by IR filter
- Insensitive to supply voltage ripple and noise
- Supply voltage: 2.0 V to 5.5 V
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



LINKS TO ADDITIONAL RESOURCES



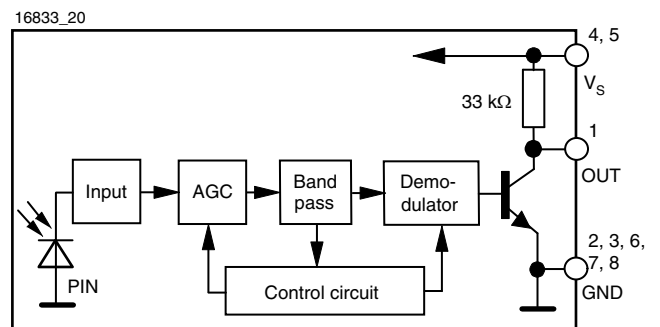
APPLICATIONS

- Object approach detection for activation of displays and user consoles, signaling of alarms, etc.
- Simple gesture controls
- Differentiation of car arrival, static, car departure in parking lots
- Reflective sensors for toilet flush
- Navigational sensor for robotics

DESIGN SUPPORT TOOLS

- [3D models](#)
- [Window size calculator](#)

BLOCK DIAGRAM

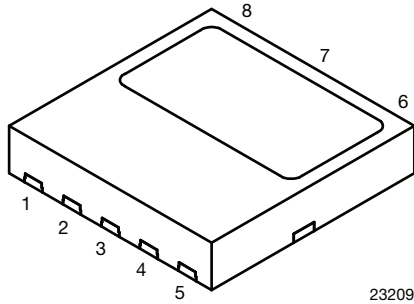




MECHANICAL DATA

Pinning:

1 = OUT, 2, 3, 6, 7, 8 = GND, 4, 5 = V_S

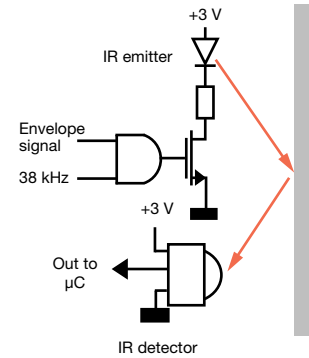


ORDERING CODE

Taping:

TSSP57P38TT1 - top view taped, 1800 pcs/reel

PROXIMITY SENSING



| PARTS TABLE | |
|-------------------|--|
| Carrier frequency | 38 kHz |
| Package | TSSP57P38 |
| Pinning | Belobog |
| Dimensions (mm) | 1 = OUT, 2, 3, 6, 7, 8 = GND, 4, 5 = V _S |
| Mounting | 3.95 W x 3.95 H x 0.8 D |
| Application | SMD |
| Special options | Proximity sensors |
| | • Extended temperature range: www.vishay.com/doc?82738 |

| ABSOLUTE MAXIMUM RATINGS | | | | |
|-----------------------------|--------------------------|------------------|--------------------------------|------|
| PARAMETER | TEST CONDITION | SYMBOL | VALUE | UNIT |
| Supply voltage | | V _S | -0.3 to +6 | V |
| Supply current | | I _S | 5 | mA |
| Output voltage | | V _O | -0.3 to (V _S + 0.3) | V |
| Output current | | I _O | 5 | mA |
| Junction temperature | | T _j | 100 | °C |
| Storage temperature range | | T _{stg} | -25 to +85 | °C |
| Operating temperature range | | T _{amb} | -25 to +85 | °C |
| Power consumption | T _{amb} ≤ 85 °C | P _{tot} | 10 | mW |

Note

- Stresses beyond those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect the device reliability



| ELECTRICAL AND OPTICAL CHARACTERISTICS (T _{amb} = 25 °C, unless otherwise specified) | | | | | | |
|---|---|---------------------|------|------|------|-------------------|
| PARAMETER | TEST CONDITION | SYMBOL | MIN. | TYP. | MAX. | UNIT |
| Supply voltage | | V _S | 2.0 | - | 5.5 | V |
| Supply current | V _S = 3.3 V, E _e = 0 | I _{SD} | 0.25 | 0.35 | 0.45 | mA |
| | E _v = 40 klx, sunlight | I _{SH} | - | 0.45 | - | mA |
| Receiving distance | Direct line of sight, IR diode TSAL6200, I _F = 50 mA, test signal see Fig. 1 | d | - | 14 | - | m |
| Output voltage low | I _{OSSL} = 0.5 mA, E _e = 0.7 mW/m ² , test signal see Fig. 1 | V _{OSSL} | - | - | 100 | mV |
| Minimum irradiance | Pulse width tolerance: t _{pi} - 5/f ₀ < t _{po} < t _{pi} + 5/f ₀ , test signal see Fig. 1 | E _{e min.} | - | 0.3 | 0.6 | mW/m ² |
| Maximum irradiance | Pulse width tolerance: t _{pi} - 5/f ₀ < t _{po} < t _{pi} + 5/f ₀ , test signal see Fig. 1 | E _{e max.} | 30 | - | - | W/m ² |
| Directivity | Angle of half receiving distance | Φ _{1/2} | - | ± 75 | - | ° |

TYPICAL CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)

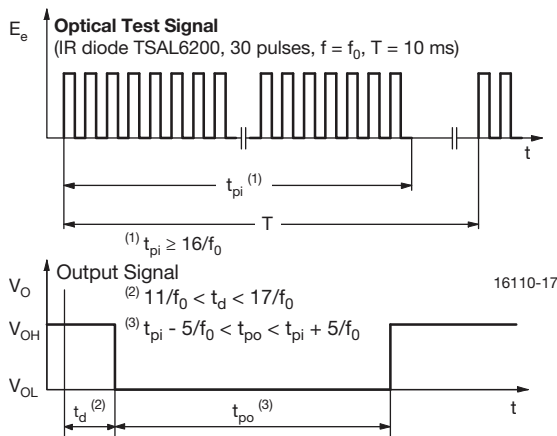


Fig. 1 - Output Active Low

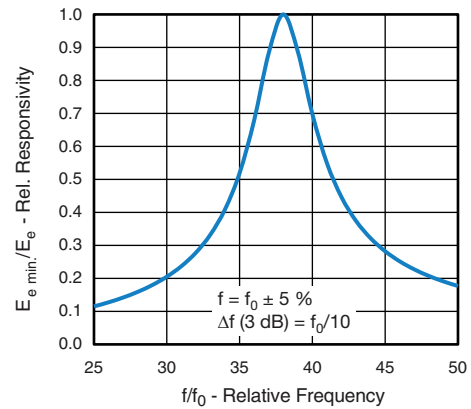


Fig. 3 - Frequency Dependence of Responsivity

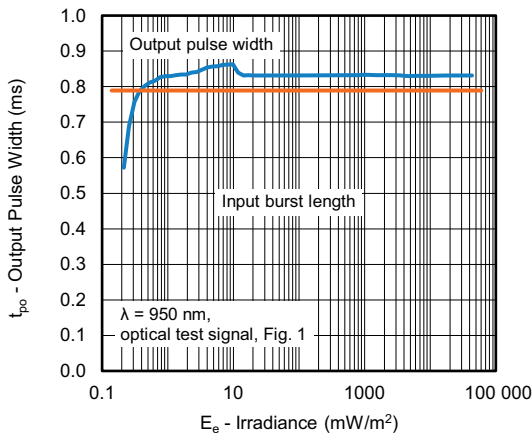


Fig. 2 - Pulse Length and Sensitivity in Dark Ambient

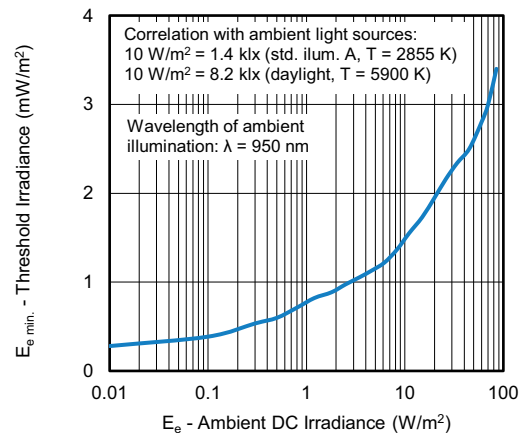


Fig. 4 - Sensitivity in Bright Ambient

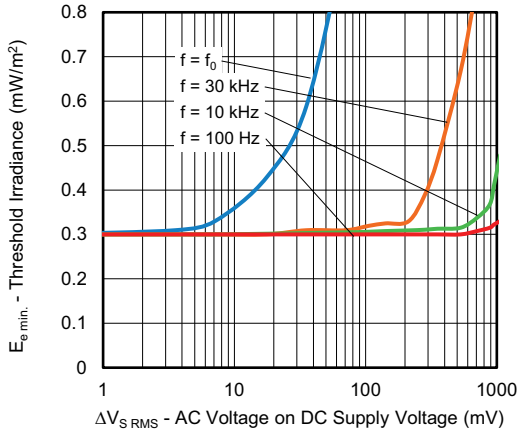


Fig. 5 - Sensitivity vs. Supply Voltage Disturbances

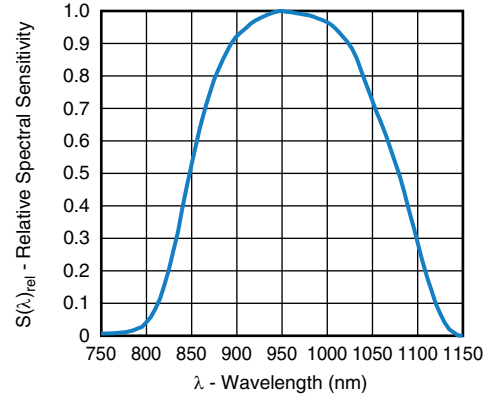


Fig. 8 - Relative Spectral Sensitivity vs. Wavelength

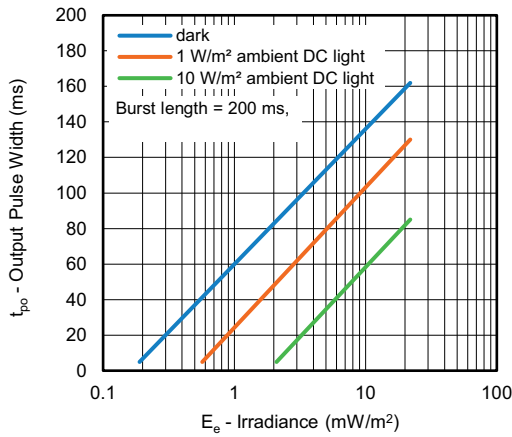


Fig. 6 - Output Pulse Width vs. Irradiance

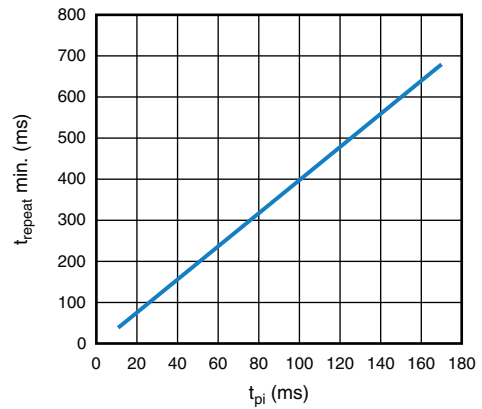


Fig. 9 - Max. Rate of Bursts

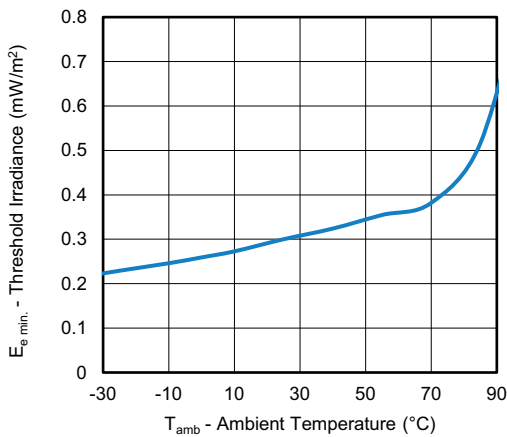


Fig. 7 - Sensitivity vs. Ambient Temperature

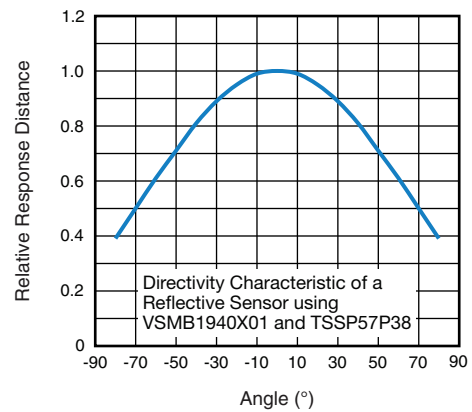


Fig. 10 - Angle Characteristic

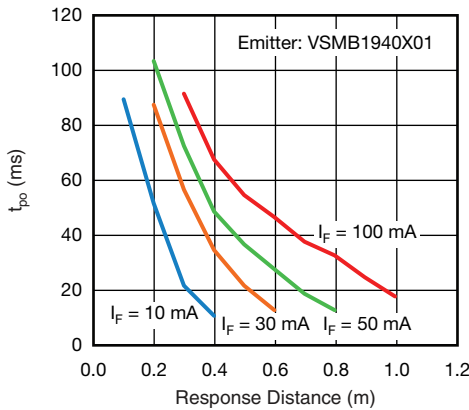


Fig. 11 - t_{po} vs. Distance

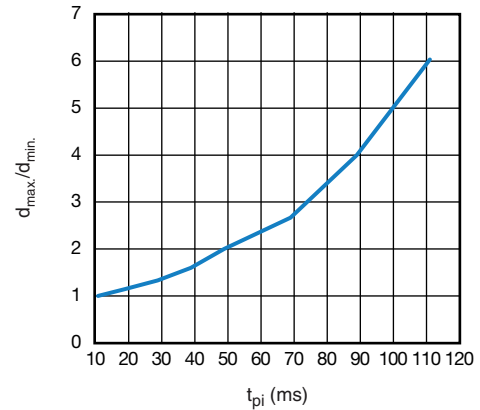
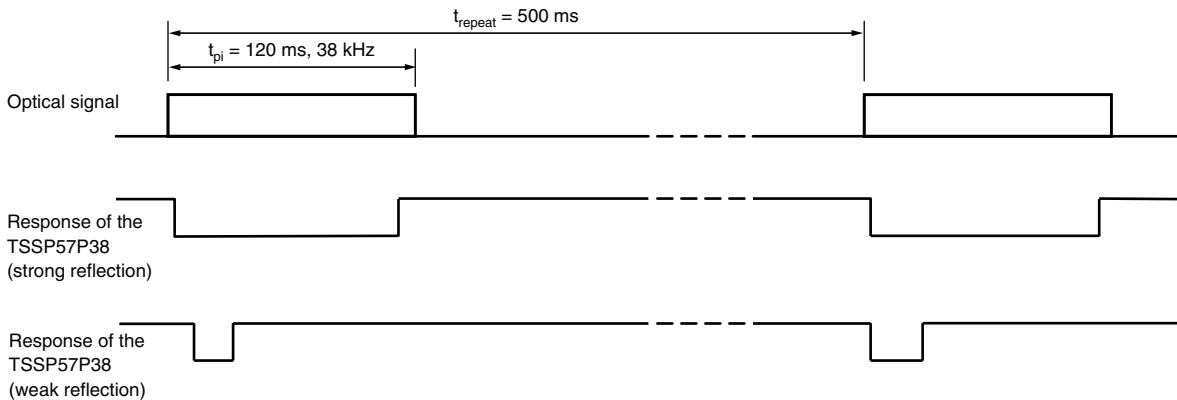


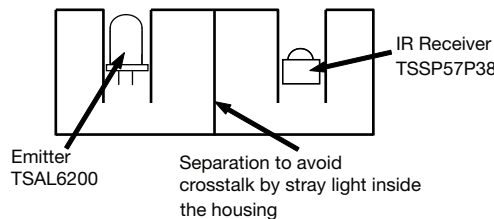
Fig. 12 - Dynamic Range of Sensor vs. t_{pi}

The typical application of the TSSP57P38 is a reflective sensor with analog information contained in its output. Such a sensor is evaluating the time required by the AGC to suppress a quasi continuous signal. The time required to suppress such a signal is longer when the signal is strong than when the signal is weak, resulting in a pulse length corresponding to the distance of an object from the sensor. This kind of analog information can be evaluated by a microcontroller. The absolute amount of reflected light depends much on the environment and is not evaluated. Only sudden changes of the amount of reflected light, and therefore changes in the pulse width, are evaluated using this application.

Example of a signal pattern:



Example for a sensor hardware:

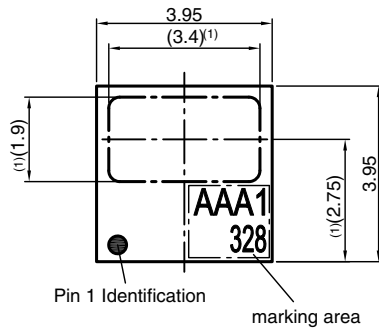
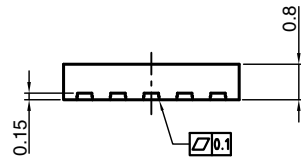
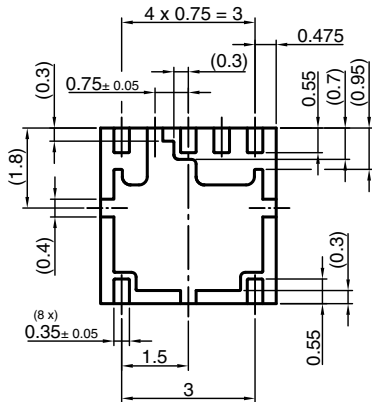


There should be no common window in front of the emitter and receiver in order to avoid crosstalk by guided light through the window.

The logarithmic characteristic of the AGC in the TSSP57P38 results in an almost linear relationship between distance and pulse width. Ambient light has also some impact to the pulse width of this kind of sensor, making the pulse shorter.

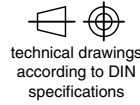


PACKAGE DIMENSIONS in millimeters

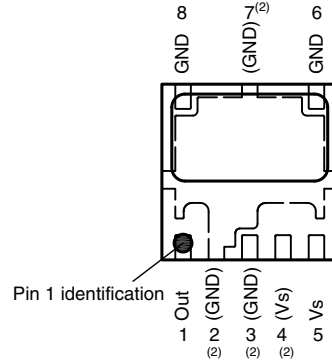


Drawing-No.: 6.550-5315.01-4
Issue: 2; 12.02.14

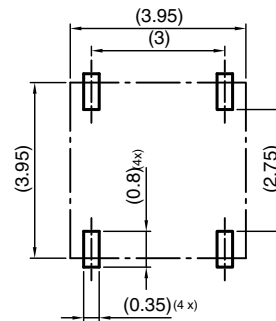
Not indicated tolerances ± 0.1



Pinning from topview



Proposed pad layout from component side (dim. for reference only)



Notes

- (1) Optically effective area
- (2) Pins connected internally. It is not necessary to connect externally



ASSEMBLY INSTRUCTIONS

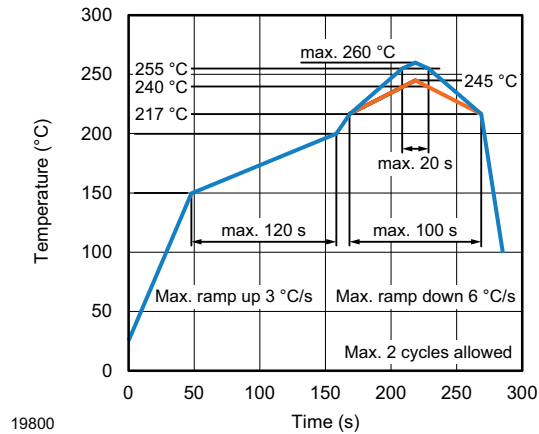
Reflow Soldering

- Reflow soldering must be done within 168 h while stored under a max. temperature of 30 °C, 60 % RH after opening the dry pack envelope
- Set the furnace temperatures for pre-heating and heating in accordance with the reflow temperature profile as shown in the diagram. Exercise extreme care to keep the maximum temperature below 260 °C. The temperature shown in the profile means the temperature at the device surface. Since there is a temperature difference between the component and the circuit board, it should be verified that the temperature of the device is accurately being measured
- Handling after reflow should be done only after the work surface has been cooled off

Manual Soldering

- Use a soldering iron of 25 W or less. Adjust the temperature of the soldering iron below 300 °C
- Finish soldering within 3 s
- Handle products only after the temperature has cooled off

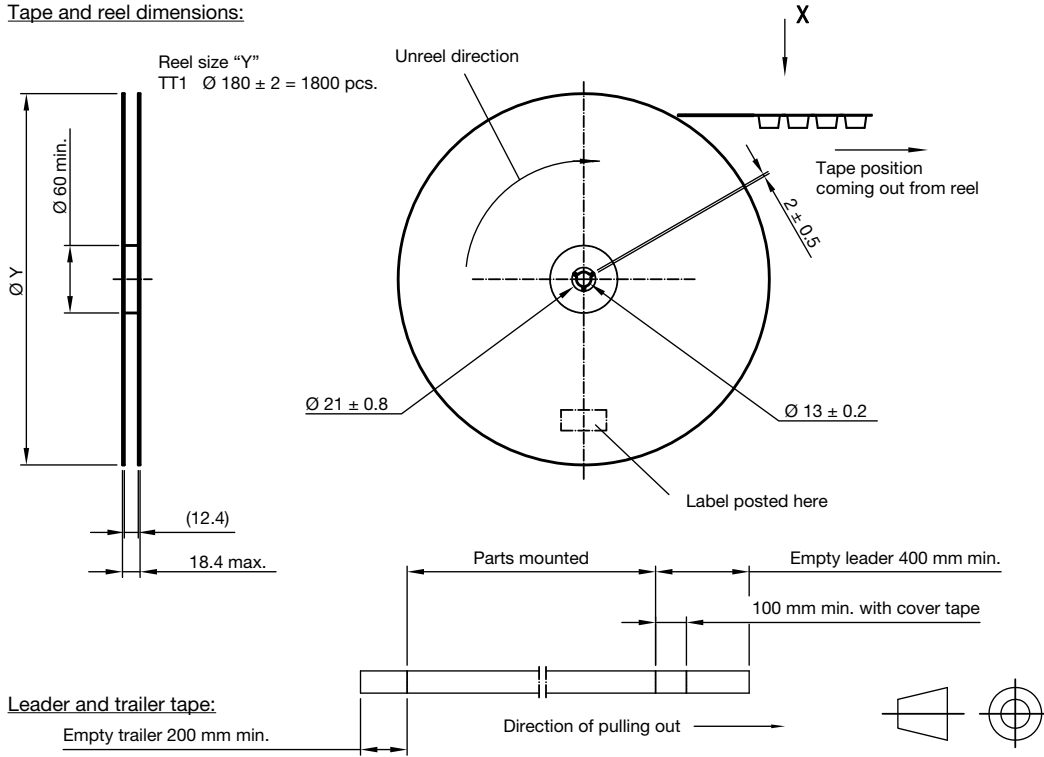
VISHAY LEAD (Pb)-FREE REFLOW SOLDER PROFILE





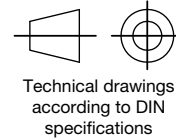
TAPING VERSION TSSP57P38 DIMENSIONS in millimeters

Tape and reel dimensions:



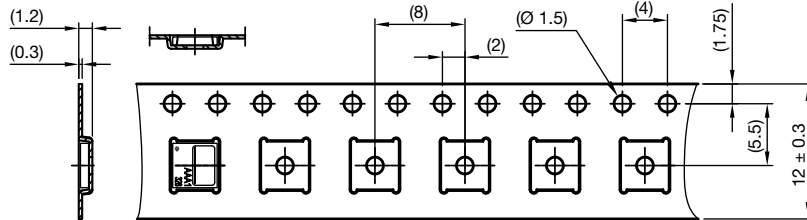
Leader and trailer tape:

Empty trailer 200 mm min.



Technical drawings according to DIN specifications

X 2:1



Drawing-No.: 9.700-5347.01-4
Issue: 2; 07.03.18

Not indicated tolerances ± 0.1



OUTER PACKAGING

The sealed reel is packed into a pizza box.

| CARTON BOX DIMENSIONS in millimeters | | | |
|--|------------------|--------------|---------------|
| | | | |
| | THICKNESS | WIDTH | LENGTH |
| Pizza box (Panhead, Heimdall, and Belobog) (taping in reels) | 50 | 340 | 340 |

LABEL

Standard bar code labels for finished goods

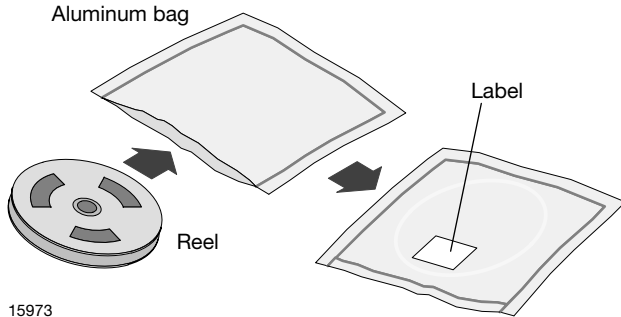
The standard bar code labels are product labels and used for identification of goods. The finished goods are packed in final packing area. The standard packing units are labeled with standard bar code labels before transported as finished goods to warehouses. The labels are on each packing unit and contain Vishay Semiconductor GmbH specific data.

| VISHAY SEMICONDUCTOR GmbH STANDARD BAR CODE PRODUCT LABEL (finished goods) | | |
|---|---------------------|---------------|
| PLAIN WRITING | ABBREVIATION | LENGTH |
| Item-description | - | 18 |
| Item-number | INO | 8 |
| Selection-code | SEL | 3 |
| LOT-/serial-number | BATCH | 10 |
| Data-code | COD | 3 (YWW) |
| Plant-code | PTC | 2 |
| Quantity | QTY | 8 |
| Accepted by | ACC | - |
| Packed by | PCK | - |
| Mixed code indicator | MIXED CODE | - |
| Origin | xxxxxxx+ | Company logo |
| LONG BAR CODE TOP | TYPE | LENGTH |
| Item-number | N | 8 |
| Plant-code | N | 2 |
| Sequence-number | X | 3 |
| Quantity | N | 8 |
| Total length | - | 21 |
| SHORT BAR CODE BOTTOM | TYPE | LENGTH |
| Selection-code | X | 3 |
| Data-code | N | 3 |
| Batch-number | X | 10 |
| Filter | - | 1 |
| Total length | - | 17 |



DRY PACKING

The reel is packed in an anti-humidity bag to protect the devices from absorbing moisture during transportation and storage.



FINAL PACKING

The sealed reel is packed into a cardboard box.

RECOMMENDED METHOD OF STORAGE

Dry box storage is recommended as soon as the aluminum bag has been opened to prevent moisture absorption. The following conditions should be observed, if dry boxes are not available:

- Storage temperature 10 °C to 30 °C
- Storage humidity ≤ 60 % RH max.

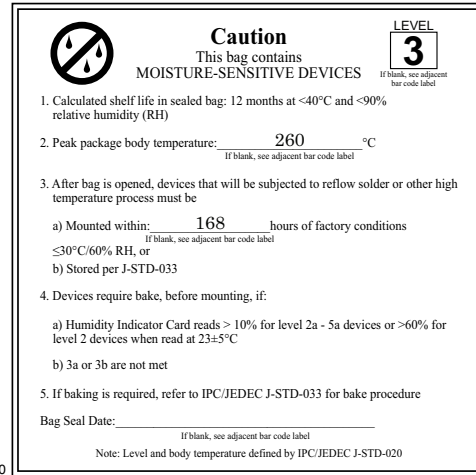
After more than 168 h under these conditions moisture content will be too high for reflow soldering.

In case of moisture absorption, the devices will recover to the former condition by drying under the following condition: 192 h at 40 °C + 5 °C / - 0 °C and < 5 % RH (dry air / nitrogen) or

96 h at 60 °C + 5 °C and < 5 % RH for all device containers or

24 h at 125 °C + 5 °C not suitable for reel or tubes.

An EIA JEDEC® standard J-STD-020 level 3 label is included on all dry bags.



EIA JEDEC standard J-STD-020 level 3 label is included on all dry bags

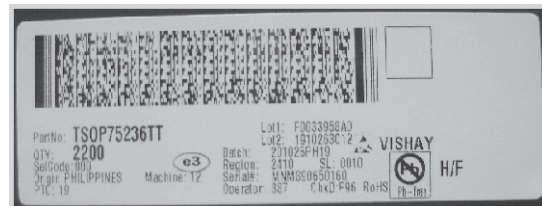
ESD PRECAUTION

Proper storage and handling procedures should be followed to prevent ESD damage to the devices especially when they are removed from the antistatic shielding bag. Electrostatic sensitive devices warning labels are on the packaging.

VISHAY SEMICONDUCTORS STANDARD BAR CODE LABELS

The Vishay Semiconductors standard bar code labels are printed at final packing areas. The labels are on each packing unit and contain Vishay Semiconductors specific data.

BAR CODE PRODUCT LABEL (Example)



22178



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